

MOSFET

OptiMOS™ 6 Power-Transistor, 200 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- 100% avalanche tested

Product validation

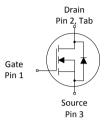
Qualified for industrial applications according to the relevant tests of JEDEC JESD47, JESD22 and J-STD-020.

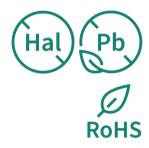
Table 1 Key performance parameters

Parameter	Value	Unit
V_{DS}	200	V
R _{DS(on),max}	17.5	mΩ
I_{D}	61	А
$Q_{\rm oss}$	95	nC
Q_{G}	31	nC
Q _{rr} (1000A/μs)	255	nC









Part number	Package	Marking	Related links
IPP175N20NM6	PG-TO220-3	175N20N6	-

Public

OptiMOS™ 6 Power-Transistor, 200 V IPP175N20NM6



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OptiMOS™ 6 Power-Transistor, 200 V IPP175N20NM6



1 Maximum ratings

at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Darameter	Symbol	Values			Limit	Note / Test condition
Parameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition
				61		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C
	,		-	46		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C
Continuous drain current 1)	I _D	-		46	Α	$V_{\rm GS}$ =15 V, $T_{\rm C}$ =100 °C
				9.7		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	244	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	209	mJ	$I_{\rm D}$ =31 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V_{GS}	-20	-	20	V	-
Power dissipation	P_{tot}	-		203	١٨/	<i>T</i> _C =25 °C
			-	3.8	W	$T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	_	175	°C	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case	R_{thJC}		0.37	0.74		
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R_{thJA}		-	62		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_i =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol		Values			Note / Test condition
Parameter	Symbol	Min.	Тур.	Max.		Note / Test condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	200	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.7	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 105 \mu \text{A}$
Zana nata walka na dunin numunt	,	-	0.1	1	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C
Zero gate voltage drain current	I _{DSS}		10	100	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Paris and the same state of th	D		14.1	15.5	mΩ	$V_{\rm GS}$ =15 V, $I_{\rm D}$ =38 A
Drain-source on-state resistance	$R_{\rm DS(on)}$		15.6	17.5	11122	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A
Gate resistance	R_{G}	-	5.4	-	Ω	-
Transconductance ⁶⁾	g_{fs}	13	26	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 38 \text{ A}$

⁶⁾ Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Syllibot	Min.	Тур.	Max.	Oilit	Note / Test condition
Input capacitance	C _{iss}		2400	3100		
Output capacitance 7)	C _{oss}	_	380	490	pF	V _{GS} =0 V, V _{DS} =100 V, <i>f</i> =1 MHz
Reverse transfer capacitance ⁷⁾	C _{rss}		17	30		
Turn-on delay time	$t_{\sf d(on)}$		12			
Rise time	t _r	- -	23		ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =19 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$		23]		
Fall time	t _f		9.8			

⁷⁾ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test condition
Gate to source charge	Q_{gs}		15.6	-	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$		8.8	-	nC	
Gate to drain charge ⁹⁾	$Q_{ m gd}$		6.2	9.3	nC	 // =100 \/ / =10 A \/ =0 to 10 \/
Switching charge	Q_{sw}]-	13	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =19 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ⁹⁾	$Q_{ m g}$		31	39	nC	
Gate plateau voltage	$V_{ m plateau}$		6.6	-	V	
Output charge ⁹⁾	$Q_{\rm oss}$	_	95	126	nC	V _{DS} =100 V, V _{GS} =0 V

⁸⁾ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

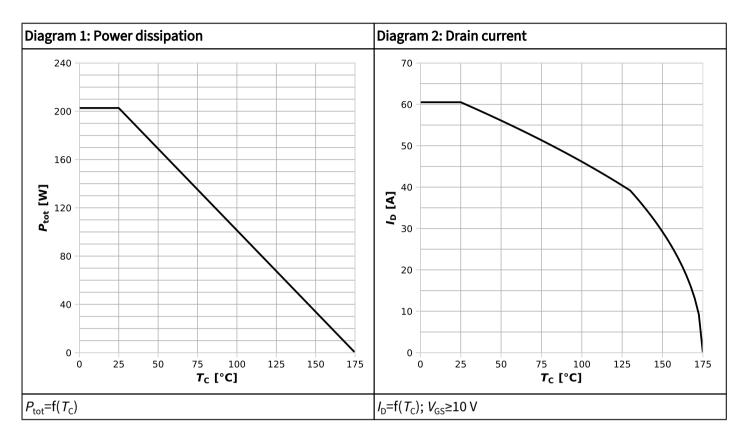
Parameter	Symbol	Values			Linit	Note / Test condition	
raiailletei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition	
Diode continuous forward current	I_{S}			61	Α	<i>T_c</i> =25 °C	
Diode pulse current	I _{S,pulse}	_	_	244	Α	7 _C -25 C	
Diode forward voltage	$V_{\rm SD}$	-	0.91	1.0	٧	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =38 A, $T_{\rm j}$ =25 °C	
Reverse recovery time	$t_{\rm rr}$		76		ns	1/_100\/	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$]-	91]-	nC	$V_{\rm R}$ =100 V, $I_{\rm F}$ =19 A, d $i_{\rm F}$ /d t =100 A/ μ s	
Reverse recovery time	t _{rr}		34		ns	1/-100 // /-10 A d:/d+1000 A/	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$	-	255]-	nC	$V_{\rm R}$ =100 V, $I_{\rm F}$ =19 A, d $i_{\rm F}$ /d t =1000 A/ μ s	

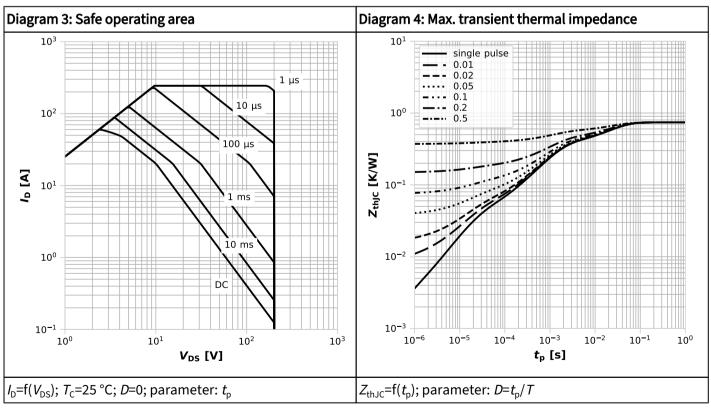
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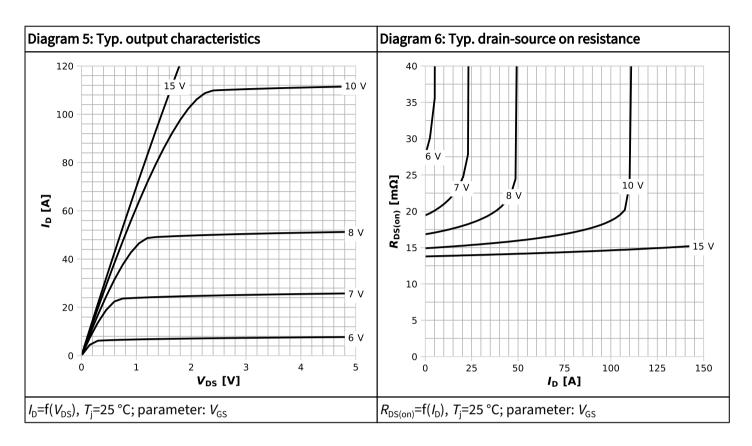


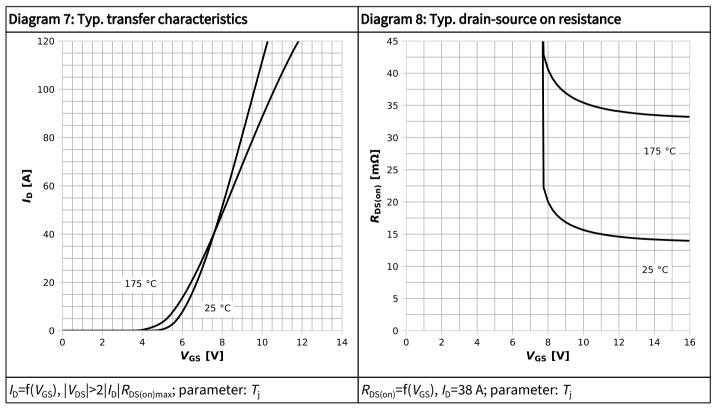
4 Electrical characteristics diagrams



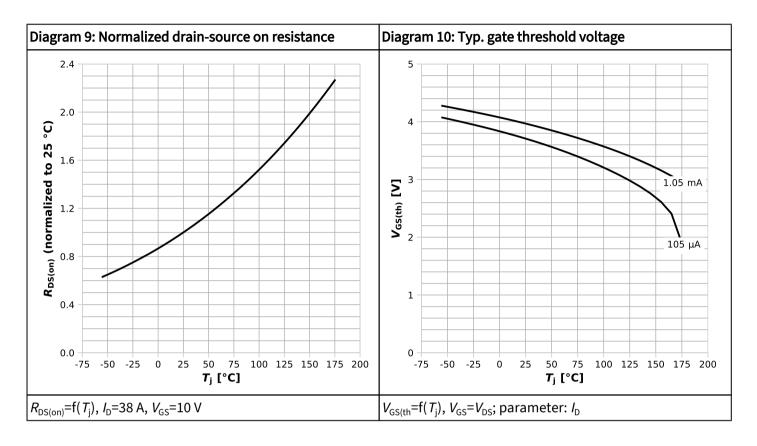


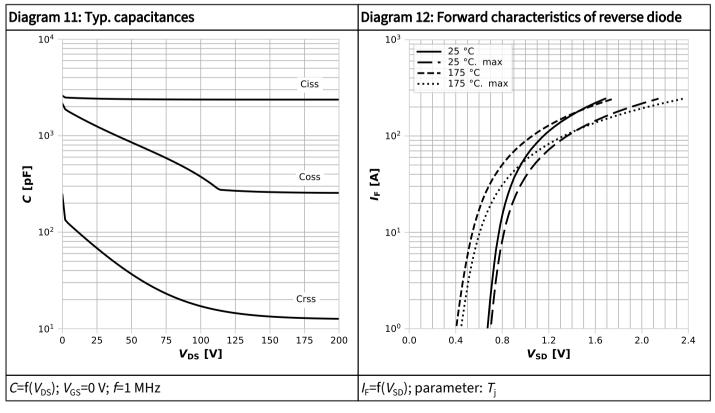




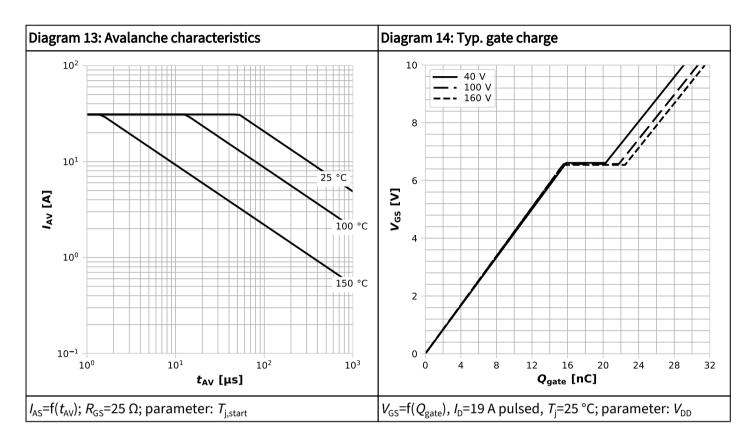


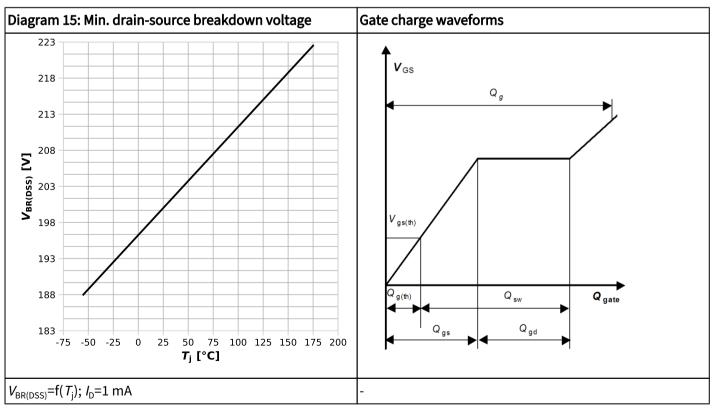














5 Package outlines

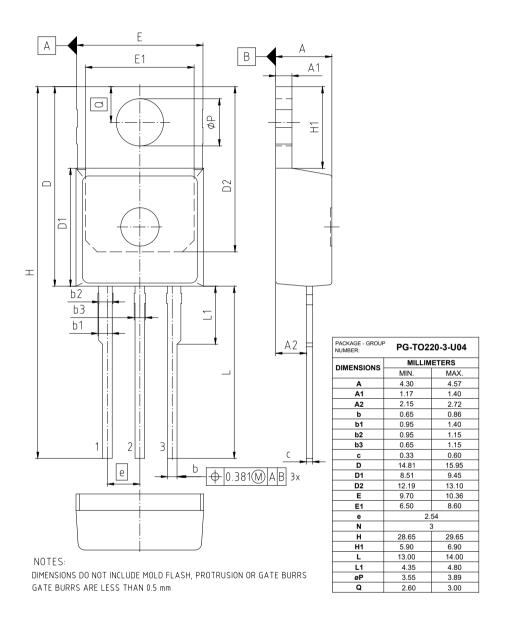


Figure 1 Outline PG-TO220-3, dimensions in mm

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Revision history

IPP175N20NM6

Revision 2025-06-11, Rev. 1.0

Previous revisions

Revision	Date	Subjects (major changes since last revision)
1.0	2025-06-11	Release of final datasheet

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